ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	burn, Illinois. All rigl	ghts reserved under	er both This do	cument i irts, the c	is a declaration declaration er	on of the substar	nces within the manufactu ower level materials for w	rer listed i hich the r	tem. Note: if nanufacturer l	the item is an as has engineering	sembly with lower responsibility.	
1752-21.1 IPC Web Site for Information on http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				ials and M	als and Mfg Information			
Supplier Information												
Company name* Company unique ID				Unique ID Authority				Response Date*				
onsemi									2025-06-06			
Contact Name	Title - Contact		Pho	Phone - Contact*			Email - Contact*					
Product-Env-Stewards	Product Enviro Co		NA	NA			Product-Env-Stewards@onsemi.com					
Authorized Representative*	orized Representative* Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Iter	n Number Mfr	Mfr Item Name		Ef	fective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
FMB22	22A 40V BIP NPN DUA		L SSOT-6	20	25-06-06		PBB		17.178	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Ferminal Base Alloy J-STD-		TD-020 MSL Rating		Peak Proce	ss Body Tempe	rature Max Time at Peak	Tempera	ture Numbe	er of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy 1					260	С	30	secor	nds 3			
Comments												
level 1 - maximum time at peak temperature during s	oldering is 10-30 seco	conds										
For more information regarding material composition	please refer to page	ge 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material Weight Unit o		Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.172	mg	Supplier	Silicon (Si)	7440-21-3		0.172	mg	
Lead Frame	8.254	mg	Supplier	Silver (Ag)	7440-22-4		0.022	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.01	mg	
			Supplier	Iron (Fe)	7439-89-6		0.198	mg	
			Supplier	Copper (Cu)	7440-50-8		8.022	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg	
Mold Compound-Black	7.596	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.52	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.076	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		6	mg	
Plating	1.13	mg	Supplier	Tin (Sn)	7440-31-5		1.13	mg	
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg	